

S-19311 Series

AUTOMOTIVE, 125°C OPERATION, 36 V INPUT, 200 mA VOLTAGE REGULATOR WITH RESET FUNCTION

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Rev.1.5 00

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The S-19311 Series, developed by using high-withstand voltage CMOS technology, is a positive voltage regulator with the reset function, which has high-withstand voltage and high-accuracy output voltage. This IC has a built-in low on-resistance output transistor which provides a small dropout voltage and a large output current. Also, a built-in overcurrent protection circuit to limit overcurrent of the output transistor and a built-in thermal shutdown circuit to limit heat are included. High heat radiation TO-252-5S(A) and HSOP-8A packages enable high-density mounting.

ABLIC Inc. offers a "thermal simulation service" which supports the thermal design in conditions when our power management ICs are in use by customers. Our thermal simulation service will contribute to reducing the risk in the thermal design at customers' development stage.

ABLIC Inc. also offers FIT rate calculated based on actual customer usage conditions in order to support customer functional safety design.

Contact our sales representatives for details.

Caution This product can be used in vehicle equipment and in-vehicle equipment. Before using the product for these purposes, it is imperative to contact our sales representatives.

Features

Regulator block

- · Output voltage: 3.0 V to 5.3 V, selectable in 0.1 V step • Input voltage: 4.0 V to 36.0 V • Output voltage accuracy: $\pm 2.0\%$ (T_i = -40° C to $+150^{\circ}$ C)
- Dropout voltage:
- Output current:
- · Input and output capacitors:
- Ripple rejection:
- 70 dB typ. (f = 100 Hz) • Built-in overcurrent protection circuit: Limits overcurrent of output transistor.
- Built-in thermal shutdown circuit:

Detector block

 Detection voltage: 	2.6 V to 5.0 V, selectable in 0.1 V step
 Detection voltage accuracy: 	±100 mV (T _j = -40°C to +150°C)
 Hysteresis width: 	0.12 V min.
 Release delay time is adjustable^{*2}: 	18 ms typ. (C _{DLY} = 47 nF)

Overall

- Current consumption:
- Operation temperature range:
- Lead-free (Sn 100%), halogen-free
- Withstand 45 V load dump
- AEC-Q100 gualified^{*3}

During operation: 60 μ A typ., 95 μ A max. (T_j = -40°C to +150°C) Ta = -40° C to $+125^{\circ}$ C

120 mV typ. (5.0 V output product, IOUT = 100 mA) Possible to output 200 mA ($V_{IN} = V_{OUT(S)} + 1.0 \text{ V}$)*1

A ceramic capacitor of 2.2 µF or more can be used.

Detection temperature 170°C typ.

- *1. Please make sure that the loss of the IC will not exceed the power dissipation when the output current is large.
- *2. The release delay time can be adjusted by connecting C_{DLY} to the DLY pin.
- *3. Contact our sales representatives for details.

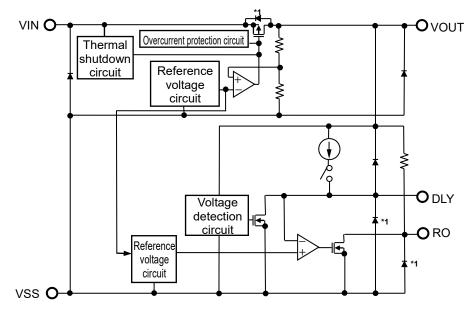
Applications

- Constant-voltage power supply and reset circuit for automotive electric component
- For automotive use (engine, transmission, suspension, ABS, related-devices for EV / HEV / PHEV, etc.)

Packages

- TO-252-5S(A)
- HSOP-8A

Block Diagram



*1. Parasitic diode

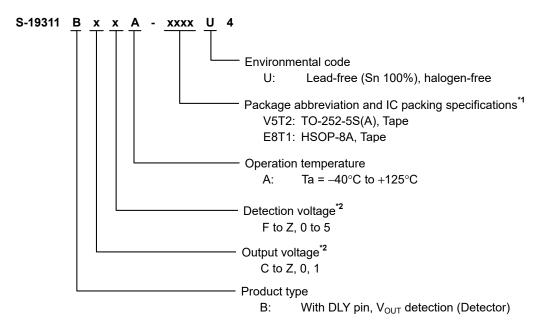
Figure 1

■ AEC-Q100 Qualified

This IC supports AEC-Q100 for the operation temperature grade 1. Contact our sales representatives for details of AEC-Q100 reliability specification.

Product Name Structure

1. Product name



- *1. Refer to the tape drawing.
- *2. Refer to "2. Product option list".

2. Product option list

Table 1 Output Voltage					
Set Output Voltage	Symbol		Set Output Voltage	Symbol	
5.3 V	С		4.1 V	Q	
5.2 V	D		4.0 V	R	
5.1 V	Е		3.9 V	S	
5.0 V	F		3.8 V	Т	
4.9 V	G		3.7 V	U	
4.8 V	Н		3.6 V	V	
4.7 V	J		3.5 V	W	
4.6 V	K		3.4 V	Х	
4.5 V	L		3.3 V	Y	
4.4 V	М		3.2 V	Z	
4.3 V	Ν		3.1 V	0	
4.2 V	Р		3.0 V	1	

	Table 2	De	tection Voltage
Set Detection Voltage	Symbol		Set Detection Voltage
5.0 V	F		3.7 V
4.9 V	G		3.6 V
4.8 V	Н		3.5 V
4.7 V	J		3.4 V
4.6 V	K		3.3 V
4.5 V	L		3.2 V
4.4 V	М		3.1 V
4.3 V	Ν		3.0 V
4.2 V	Р		2.9 V
4.1 V	Q		2.8 V
4.0 V	R		2.7 V
3.9 V	S		2.6 V

Т

Set Detection Symbol Voltage 3.7 V U 3.6 V V 3.5 V W

Х

Y Ζ

0

1

2

3

4

5

Remark Set output voltage \geq Set detection voltage + 0.3 V

3.8 V

3. Packages

Table 5 Package Drawing Codes							
Package Name	Dimension	Tape	Reel	Land			
TO-252-5S(A)	VA005-A-P-SD	VA005-A-C-SD	VA005-A-R-SD	VA005-A-L-SD			
HSOP-8A	FH008-A-P-SD	FH008-A-C-SD	FH008-A-R-SD	FH008-A-L-SD			

Table 3 Package Drawing Codes

4. Product name list

 Table 4							
Output Voltage	Detection Voltage	TO-252-5S(A)	HSOP-8A				
$5.0 V \pm 2.0\%$	$2.9 \text{ V} \pm 0.1 \text{ V}$	S-19311BF2A-V5T2U4	S-19311BF2A-E8T1U4				
$5.0~V\pm2.0\%$	$4.1~V\pm0.1~V$	S-19311BFQA-V5T2U4	S-19311BFQA-E8T1U4				
$5.0~V\pm2.0\%$	$4.5~V\pm0.1~V$	S-19311BFLA-V5T2U4	S-19311BFLA-E8T1U4				
$5.0~V\pm2.0\%$	$4.6 \text{ V} \pm 0.1 \text{ V}$	S-19311BFKA-V5T2U4	S-19311BFKA-E8T1U4				
$5.0~V\pm2.0\%$	$4.7 \text{ V} \pm 0.1 \text{ V}$	S-19311BFJA-V5T2U4	S-19311BFJA-E8T1U4				

Remark Please contact our sales representatives for products other than the above.

Pin Configurations

1. TO-252-5S(A)

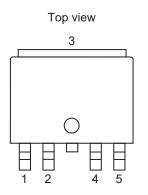


Table 5						
Pin No.	Symbol	Description				
1	VIN	Voltage input pin (Regulator block)				
2	VOUT	Voltage output pin (Regulator block)				
3	VSS	GND pin				
4	DLY	Connection pin for release delay time adjustment capacitor				
5	RO	Reset output pin				

Figure 2

2. HSOP-8A

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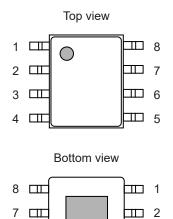


Table 6						
Pin No.	Symbol	Description				
1	VOUT	Voltage output pin (Regulator block)				
2	NC*2	No connection				
3	VSS	GND pin				
4	DLY	Connection pin for release delay time adjustment capacitor				
5	RO	Reset output pin				
6	NC*2	No connection				
7	NC*2	No connection				
8	VIN	Voltage input pin (Regulator block)				

Figure 3

*1. Connect the heat sink of backside at shadowed area to the board, and set electric potential GND. However, do not use it as the function of electrode.

***2.** The NC pin is electrically open.

The NC pin can be connected to the VDD pin or the VSS pin.

□□ 3 □□ 4

Absolute Maximum Ratings

Table 7

		(T _j = –40°C to +150°C unless oth	erwise specified)
Item	Symbol	Absolute Maximum Rating	Unit
VIN pin voltage	VIN	$V_{SS} - 0.3$ to $V_{SS} + 45.0$	V
VOUT pin voltage	Vout	$V_{SS}-0.3$ to $V_{IN}+0.3 \leq V_{SS}+7.0$	V
DLY pin voltage	VDLY	$V_{\text{SS}} - 0.3$ to $V_{\text{OUT}} + 0.3 \leq V_{\text{SS}} + 7.0$	V
RO pin voltage	V _{RO}	$V_{\text{SS}} - 0.3$ to $V_{\text{OUT}} + 0.3 \leq V_{\text{SS}} + 7.0$	V
Output current	Ιουτ	260	mA
Junction temperature	Tj	-40 to +150	°C
Operation ambient temperature	T _{opr}	-40 to +125	°C
Storage temperature	T _{stg}	-40 to +150	°C

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

■ Thermal Resistance Value

Table 8

Item	Symbol	Condition		Min.	Тур.	Max.	Unit
			Board A		86	-	°C/W
			Board B	I	60	I	°C/W
		TO-252-5S(A)	Board C	I	38	I	°C/W
			Board D	-	31	_	°C/W
Junction-to-ambient thermal	θја		Board E	_	28	_	°C/W
resistance ^{*1}		Board	Board A	-	104	-	°C/W
			Board B	I	74	I	°C/W
			Board C	_	39		°C/W
			Board D	_	37	_	°C/W
			Board E	-	31	-	°C/W

*1. Test environment: compliance with JEDEC STANDARD JESD51-2A

Remark Refer to "■ **Power Dissipation**" and "**Test Board**" for details.

Recommended Operation Conditions

Table 9							
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	
VIN pin voltage	VIN	-	4.0	-	36.0	V	
VOUT pin voltage	Vout	Detector block	1.0	_	I	V	
Input capacitance	CIN	-	2.2	_	I	μF	
Output capacitance	CL	-	2.2	_	I	μF	
Equivalent series resistance	Resr	Output capacitor (CL)	I	_	10	Ω	
Release delay time adjustment capacitance*1	CDLY	-	1	47	I	nF	
External pull-up resistance for output pin	Rext	-	3	-	-	kΩ	

*1. Refer to "2. Release delay time adjustment capacitor (C_{DLY})" in "■ Selection of External Parts" for the details.

Caution 1. Generally a series regulator may cause oscillation, depending on the selection of external parts. Confirm that no oscillation occurs in the actual application using capacitors that meet the above C_{IN}, C_L, and R_{ESR}.

2. Define the external pull-up resistance by sufficient evaluation including the temperature characteristics under the actual usage conditions.

Electrical Characteristics

1. Regulator block

Table 10

		(V _{IN} = 13.5 V, T _j =	-40°C to	+150°C	unless otł	nerwise	specified)
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Output voltage*1	V _{OUT(E)}	V _{IN} = 13.5 V, I _{OUT} = 30 mA	V _{OUT(S)} - 2.0%	Vout(s)	V _{OUT(S)} + 2.0%	V	1
Output current*2	Іоит	$V_{IN} \ge V_{OUT(S)} + 1.0 V$	200*7	_	-	mA	2
Dropout voltogo*3		I _{OUT} = 30 mA, Ta = +25°C, V _{OUT(S)} = 3.0 V to 5.3 V	-	40	50	mV	1
Dropout voltage*3	V _{drop}	l _{OUT} = 100 mA, Ta = +25°C, V _{OUT(S)} = 3.0 V to 5.3 V	-	120	200	mV	1
Line regulation*4	$\frac{\Delta V_{\text{OUT1}}}{\Delta V_{\text{IN}} \bullet V_{\text{OUT}}}$	$V_{OUT(S)}$ + 1.0 V \leq V _{IN} \leq 36.0 V, I _{OUT} = 30 mA, Ta = +25°C	-	0.02	0.10	%/V	1
Load regulation* ⁵	ΔV_{OUT2}	$V_{\text{IN}} = 13.5 \text{ V}, \ 100 \ \mu\text{A} \le I_{\text{OUT}} \le 100 \ \text{mA}, \ Ta = +25^{\circ}\text{C}$	-	20	40	mV	1
Input voltage	VIN	_	4.0	_	36.0	V	_
Ripple rejection	RR	V _{IN} = 13.5 V, I _{OUT} = 30 mA, f = 100 Hz, ΔV _{rip} = 1.0 V _{p-p}	-	70	-	dB	3
Limit current*6	I _{LIM}	V _{IN} = V _{OUT(S)} + 1.0 V, V _{OUT} = 1.2 V, Ta = +25°C	260	500	700	mA	2
Short-circuit current	Ishort	V _{IN} = 13.5 V, V _{OUT} = 0 V, Ta = +25°C	30	60	80	mA	2
Thermal shutdown detection temperature	Tsd	Junction temperature	_	170	_	°C	_
Thermal shutdown release temperature	Tsr	Junction temperature	_	135	_	°C	_

*1. The accuracy is guaranteed when the input voltage, output current, and temperature satisfy the conditions listed above.

 $V_{\text{OUT}(S)}: \quad \text{Set output voltage}$

 $V_{\text{OUT}(\text{E})}: \quad \text{Actual output voltage}$

*2. The output current when increasing the output current gradually until the output voltage has reached the value of 95% of V_{OUT(E)}.

*3. The difference between input voltage (V_{IN1}) and the output voltage when decreasing input voltage (V_{IN}) gradually until the output voltage has dropped out to the value of 98% of output voltage (V_{OUT3}).

 V_{drop} : $V_{IN1} - (V_{OUT3} \times 0.98)$

 V_{OUT3} : Output voltage when V_{IN} = $V_{\text{OUT}(S)}$ + 1.0 V

- *4. The dependency of the output voltage against the input voltage. The value shows how much the output voltage changes due to a change in the input voltage while keeping output current constant.
- ***5.** The dependency of the output voltage against the output current. The value shows how much the output voltage changes due to a change in the output current while keeping input voltage constant.

*6. The current limited by overcurrent protection circuit.

*7. Due to limitation of the power dissipation, this value may not be satisfied. Attention should be paid to the power dissipation when the output current is large.

This specification is guaranteed by design.

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2. Detector block

Table 11

		(V _{IN} = 13.5 V	, T _j = –40°0	C to +150°	C unless of	therwise s	specified)
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Detection voltage ^{*1}	-Vdet	_	-V _{DET(S)} - 0.1	-V _{DET(S)}	-V _{DET(S)} + 0.1	V	4
Hysteresis width*2	V _{HYS}	_	120	150	-	mV	4
Reset output voltage "H"	V _{ROH}	-	$V_{OUT(S)} imes 0.9$	-	-	V	4
Reset output voltage "L"	V _{ROL}	$V_{OUT} \ge 1.0 \text{ V}, \text{ R}_{extR} \ge 3 \text{ k}\Omega,$ Connected to VOUT pin	_	0.2	0.4	V	4
Reset pull-up resistance	R _{RO}	VOUT pin internal resistance	20	30	45	kΩ	-
Reset output current	I _{RO}	V_{RO} = 0.4 V, V_{OUT} = $-V_{DET(S)} - 0.1$ V	3.0	_	_	mA	5
Release delay time*3	t _{rd}	C _{DLY} = 47 nF	11	18	25	ms	4
Reset reaction time*4	trr	C _{DLY} = 47 nF	_	_	50	μs	4

*1. The voltage at which the output of the RO pin turns to "L". The accuracy is guaranteed when the input voltage and temperature satisfy the listed conditions above.

 $-V_{\text{DET}(S)}$: Set detection voltage

-VDET: Actual detection voltage

*2. The voltage difference between the detection voltage ($-V_{DET}$) and the release voltage ($+V_{DET}$). The relation between the actual output voltage ($V_{OUT(E)}$) of the regulator block and the actual release voltage ($+V_{DET} = -V_{DET} + V_{HYS}$) of the detector block is as follows.

 $V_{\text{OUT}(\text{E})} > + V_{\text{DET}}$

*3. The time from when V_{OUT} exceeds +V_{DET} to when the RO pin output inverts (Refer to **Figure 4**). This value changes according to the release delay time adjustment capacitor (C_{DLY}).

The time period from when V_{OUT} changes to $+V_{DET} \rightarrow V_{OUT(S)}$ to when V_{RO} reaches V_{OUT} / 2.

*4. The time from when V_{OUT} falls below $-V_{DET}$ to when the RO pin output inverts (Refer to Figure 5). The time period from when V_{OUT} changes to V_{OUT}(s) $\rightarrow -V_{DET}$ to when V_{RO} reaches V_{OUT} / 2.

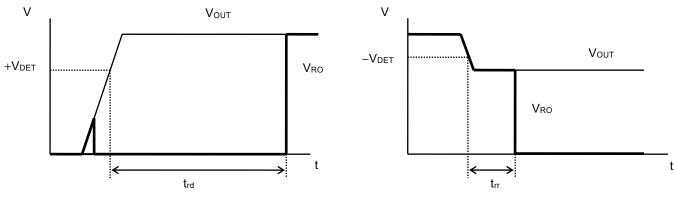


Figure 4 Release Delay Time

Figure 5 Reset Reaction Time

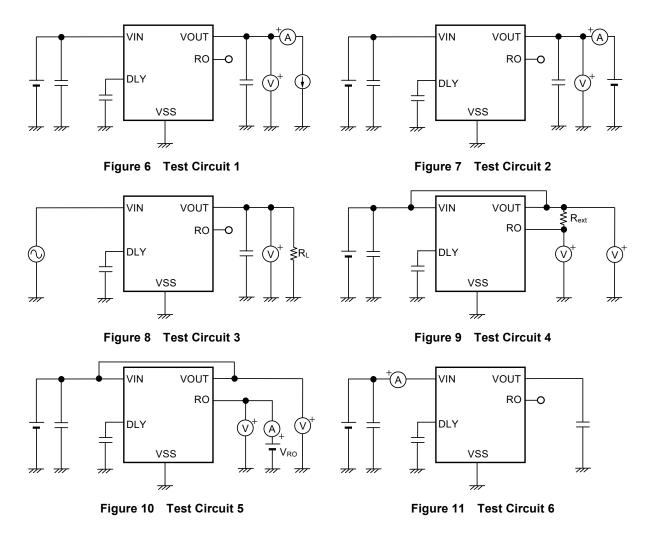
4. Overall

Table 12

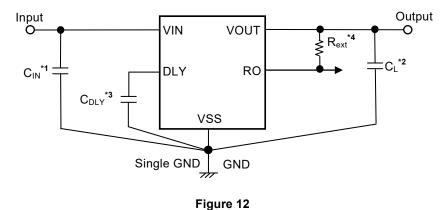
(VIN = 13.5 V.	$\Gamma_j = -40^{\circ}$ C to +150°C unless otherwise specified)	
	VIIN 10.0 V,		

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Test Circuit
Current consumption during operation	Iss1	V _{IN} = 13.5 V, I _{OUT} = 0 mA	_	60	95	μA	6

Test Circuits



Standard Circuit



- *1. C_{IN} is a capacitor for stabilizing the input.
 *2. C_L is a capacitor for stabilizing the output. A ceramic capacitor of 2.2 μF or more can be used.
- ***3.** C_{DLY} is the release delay time adjustment capacitor.
- *4. R_{ext} is the external pull-up resistor for the reset output pin.
 Connection of the external pull-up resistor is not absolutely essential since the S-19311 Series has a built-in pull-up resistor.
- Caution The above connection diagram and constants will nt guarantee successful operation. Perform thorough evaluation using an actual application to set the constants.

Selection of External Parts

1. Input and output capacitors (C_{IN}, C_L)

The S-19311 Series requires C_L between the VOUT pin and the VSS pin for phase compensation. Operation is stabilized by a ceramic capacitor with an output capacitance of 2.2 μ F or more over the entire temperature range. When using an OS capacitor, a tantalum capacitor, or an aluminum electrolytic capacitor, the capacitance must be 2.2 μ F or more, and the ESR must be 10 Ω or less.

The values of output overshoot and undershoot, which are transient response characteristics, vary depending on the value of the output capacitor.

The required value of capacitance for the input capacitor differs depending on the application.

Caution Define the capacitance of C_{IN} and C_L by sufficient evaluation including the temperature characteristics under the actual usage conditions.

2. Release delay time adjustment capacitor (C_{DLY})

In the S-19311 Series, the release delay time adjustment capacitor (C_{DLY}) is necessary between the DLY pin and the VSS pin to adjust the release delay time (t_{rd}) of the detector.

The set release delay time $(t_{rd(S)})$ is calculated by using the following equation.

The release delay time (t_{rd}) at the time of the condition of C_{DLY} = 47 nF is shown in "■ Electrical Characteristics".

 $t_{rd(S)} \text{ [ms]} = t_{rd} \text{ [ms]} \times \frac{C_{\text{DLY}} \text{ [nF]}}{47 \text{ [nF]}}$

- Caution 1. The above equation will not guarantee successful operation. Perform thorough evaluation including the temperature characteristics using an actual application to set the constants.
 - 2. Mounted board layout should be made in such a way that no current flows into or flows from the DLY pin since the impedance of the DLY pin is high, otherwise correct delay time and monitoring time may not be provided.
 - Select C_{DLY} whose leakage current can be ignored against the built-in constant current (5.0 μA typ.). The leakage current may cause deviation in delay time and monitoring time. When the leakage current is larger than the built-in constant current, no release takes place.
 - 4. Deviations of C_{DLY} are not included in the equation mentioned above. Be sure to determine the constants considering the deviation of C_{DLY} to be used.

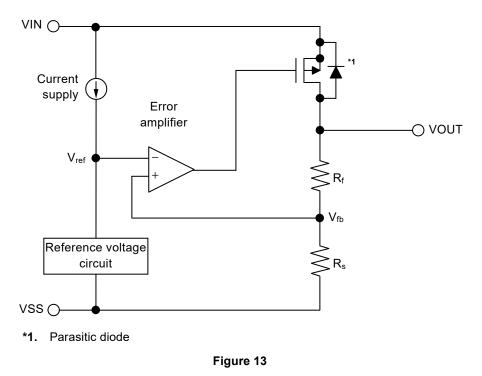
Operation

1. Regulator block

1.1 Basic operation

Figure 13 shows the block diagram of the regulator in the S-19311 Series.

The error amplifier compares the reference voltage (V_{ref}) with feedback voltage (V_{fb}), which is the output voltage resistance-divided by feedback resistors (R_s and R_f). It supplies the gate voltage necessary to maintain the constant output voltage which is not influenced by the input voltage and temperature change, to the output transistor.



1.2 Output transistor

In the S-19311 Series, a low on-resistance P-channel MOS FET is used as the output transistor.

Be sure that V_{OUT} does not exceed $V_{IN} + 0.3$ V to prevent the voltage regulator from being damaged due to reverse current flowing from the VOUT pin through a parasitic diode to the VIN pin, when the potential of V_{OUT} became higher than V_{IN} .

1.3 Overcurrent protection circuit

The S-19311 Series includes an overcurrent protection circuit which having the characteristics shown in "1. 1 Output voltage vs. Output current (When load current increases) ($Ta = +25^{\circ}C$)" of "1. Regulator block" in "
Characteristics (Typical Data)", in order to limit an excessive output current and overcurrent of the output transistor due to short-circuiting between the VOUT pin and the VSS pin. The current when the output pin is short-circuited (I_{short}) is internally set at 60 mA typ., and the load current when short-circuiting is limited based on this value. The output voltage restarts regulating if the output transistor is released from overcurrent status.

Caution This overcurrent protection circuit does not work as for thermal protection. If this IC long keeps short circuiting, pay attention to the conditions of input voltage and load current so that, under the usage conditions including short circuit, the loss of the IC will not exceed power dissipation.

1.4 Thermal shutdown circuit

The S-19311 Series has a thermal shutdown circuit to limit self-heating. When the junction temperature rises to 170° C typ., the thermal shutdown circuit operates to stop regulating. After that, when the junction temperature drops to 135° C typ., the thermal shutdown circuit is released to restart regulating.

Due to self-heating of the S-19311 Series, if the thermal shutdown circuit starts operating, it stops regulating so that the output voltage drops. For this reason, self-heating is limited and the IC's temperature drops.

When the temperature drops, the thermal shutdown circuit is released to restart regulating, thus self-heating is generated again due to rising of the output voltage. Repeating this procedure makes the waveform of the VOUT pin output into a pulse-like form. This phenomenon continues unless decreasing either or both of the input voltage and the output current in order to reduce the internal power consumption, or decreasing the ambient temperature. Note that the product may suffer physical damage such as deterioration if the above phenomenon occurs continuously.

Table 13						
Thermal Shutdown Circuit	VOUT Pin Voltage					
Detect: 170°C typ.*1	Vss level					
Release: 135°C typ.*1	Set value					

***1.** Junction temperature

2. Detector block

2.1 Basic operation

- (1) When the output voltage (V_{OUT}) of the regulator is release voltage (+V_{DET}) of the detector or higher, the Nch transistor (N1 and N2) are turned off and "H" is output to the RO pin. Since the Pch transistor (P1) is turned on, the input voltage to the comparator (C1) is $\frac{R_B \bullet V_{OUT}}{R_A + R_B}$.
- (2) Even if V_{OUT} decreases to +V_{DET} or lower, "H" is output to the RO pin when V_{OUT} is the detection voltage (-V_{DET}) or higher. When V_{OUT} decreases to $-V_{DET}$ (point A in **Figure 15**) or lower, N1 which is controlled by C1 is turned on, and C_{DLY} is discharged. If the DLY pin voltage (V_{DLY}) decreases to the lower reset timing threshold voltage (V_{DRL}) or lower, N2 of output stage of C2 is turned on, and then "L" is output to the RO pin. At this time, P1 is turned off, and the input voltage to C1 is $\frac{R_B \bullet V_{OUT}}{R_A + R_B + R_C}$.
- (3) If Vout further decreases to the IC's minimum operation voltage or lower, the RO pin output is "H".
- (4) When V_{OUT} increases to the IC's minimum operation voltage or higher, "L" is output to the RO pin. Moreover, even if V_{OUT} exceeds –V_{DET}, the output is "L" when V_{OUT} is lower than +V_{DET}.
- (5) When V_{OUT} increases to +V_{DET} (point B in Figure 15) or higher, N1 is turned off and C_{DLY} is charged. N2 is turned off if V_{DLY} increases to the upper timing threshold voltage (V_{DU}) or higher, and "H" is output to the RO pin.

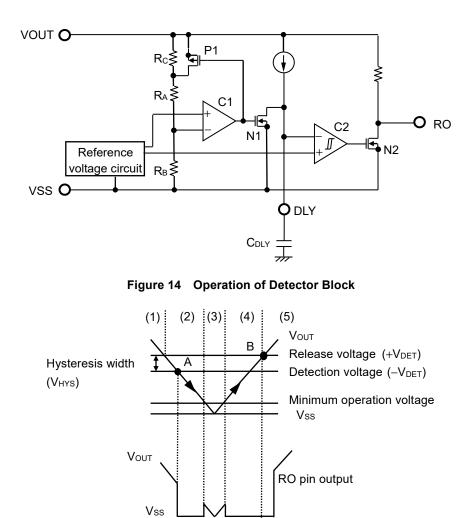


Figure 15 Timing Chart of Detector Block

trd

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2.2 Delay circuit

When the output voltage (V_{OUT}) of the regulator rises under the status that "L" is output to the RO pin, the reset release signal is output to the RO pin later than when V_{OUT} becomes $+V_{DET}$. The release delay time (t_{rd}) changes according to C_{DLY} . Refer to "2. Release delay time adjustment capacitor (C_{DLY})" in " \blacksquare Selection of External Parts" for details.

In addition, if the time from when V_{OUT} decreases to $-V_{DET}$ or lower to when V_{OUT} increases to $+V_{DET}$ or higher is significantly shorter compared to the length of the reset reaction time (t_{rr}), V_{DLY} may not decrease to V_{DRL} or lower. In that case, "H" output remains in the RO pin. Refer to "**2. 9** Reset reaction time vs. Release delay time adjustment capacitance" in "**E** Characteristics (Typical Data)" for the details.

Caution Since t_{rd} depends on the charge time of C_{DLY}, t_{rd} may be shorter than the set value if the charge operation is initiated under the condition that a residual electric charge is left in C_{DLY}.

2.3 Output circuit

Since the RO pin has a built-in resistor to pull up to the VOUT pin internally, the RO pin can output a signal without an external pull-up resistor

Do not connect to the pin other than VOUT pin when connecting an external pull-up resistor.

Caution Define the external pull-up resistance by sufficient evaluation including the temperature characteristics under the actual usage conditions.

Timing Chart

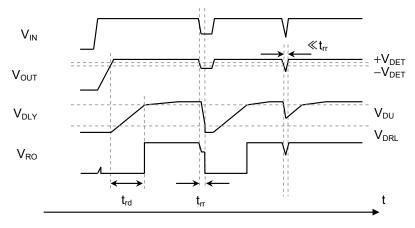


Figure 16 Example of Detector Operation

Precautions

- Wiring patterns for the VIN pin, the VOUT pin and GND should be designed so that the impedance is low. When
 mounting an output capacitor between the VOUT pin and the VSS pin (CL) and an input capacitor between the VIN
 pin and the VSS pin (CIN), the distance from the capacitors to these pins should be as short as possible.
- Note that generally the output voltage may increase when a series regulator is used at low load current (0.1 mA or less).
- Note that generally the output voltage may increase due to the leakage current from an output transistor when a series regulator is used at high temperature.
- Generally a series regulator may cause oscillation, depending on the selection of external parts. The following conditions are recommended for the S-19311 Series. However, be sure to perform sufficient evaluation under the actual usage conditions for selection, including evaluation of temperature characteristics. Refer to "4. Example of equivalent series resistance vs. Output current characteristics (Ta = -40°C to +125°C)" in "■ Reference Data" for the equivalent series resistance (RESR) of the output capacitor.

Input capacitor (C _{IN}):	$2.2 \ \mu\text{F}$ or more
Output capacitor (C _L):	$2.2 \ \mu\text{F}$ or more

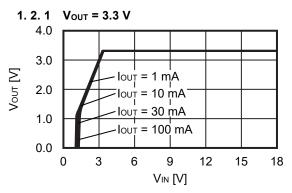
- In a series regulator, generally the values of overshoot and undershoot in the output voltage vary depending on the variation factors of power-on, power supply fluctuation and load fluctuation, or output capacitance. Determine the conditions of the output capacitor after sufficiently evaluating the temperature characteristics of overshoot or undershoot in the output voltage with the actual device.
- The voltage regulator may oscillate when the impedance of the power supply is high and the input capacitance is small or an input capacitor is not connected.
- Overshoot may occur in the output voltage momentarily if the voltage is rapidly raised at power-on or when the power supply fluctuates. Sufficiently evaluate the output voltage at that time with the actual device.
- If the VOUT pin is steeply shorted with GND, a negative voltage exceeding the absolute maximum ratings may occur to the VOUT pin due to resonance of the wiring inductance and the output capacitance in the application. The negative voltage can be limited by inserting a protection diode between the VOUT pin and the VSS pin or inserting a series resistor to the output capacitor.
- The application conditions for the input voltage, the output voltage, and the load current should not exceed the power dissipation.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- In determining the output current, attention should be paid to the output current value specified in Table 10 in "■ Electrical Characteristics" and footnote *7 of the table.
- ABLIC Inc. claims no responsibility for any disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

Characteristics (Typical Data)

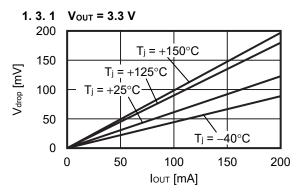
1. Regulator block

- 1.1 Output voltage vs. Output current (When load current increases) (Ta = +25°C)
- 1.1.1 V_{OUT} = 3.3 V 4.0 3.0 Vour [V] Vin = 3.8 V 2.0 . Vin = 13.5 V VIN = 4.3 V 1.0 0.0 0 100 200 300 400 500 600 IOUT [mA]

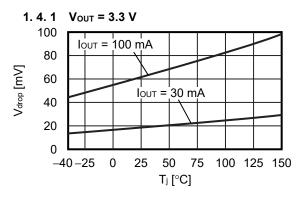


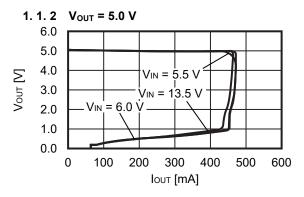


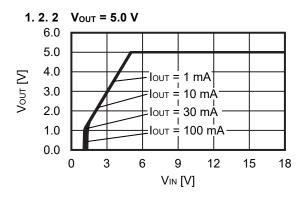
1.3 Dropout voltage vs. Output current

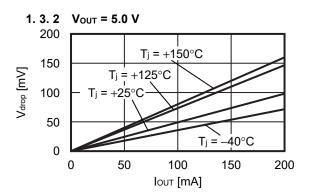


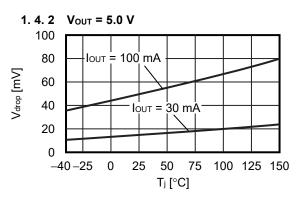
1.4 Dropout voltage vs. Junction temperature







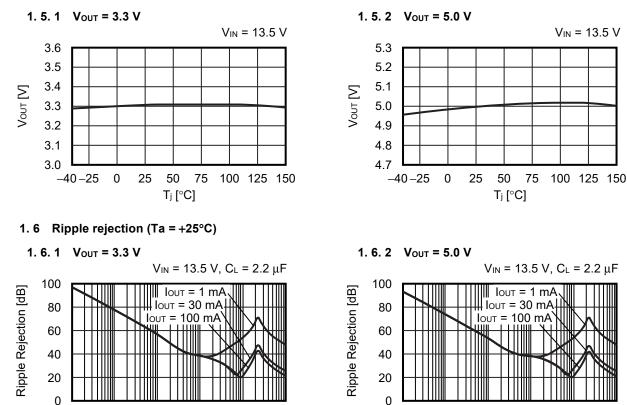




ABLIC Inc.

AUTOMOTIVE, 125°C OPERATION, 36 V INPUT, 200 mA VOLTAGE REGULATOR WITH RESET FUNCTION S-19311 Series Rev.1.5_00

1.5 Output voltage vs. Junction temperature



2. Detector block

10

100

2.1 Detection voltage, Release voltage vs. Junction temperature

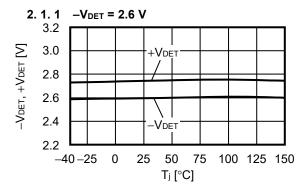
10k

100k

1M

10

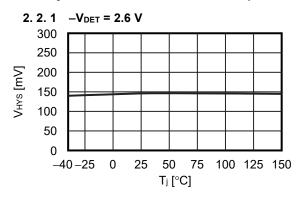
100

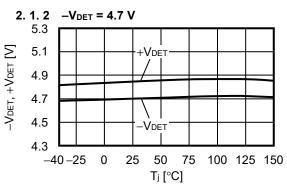


1k

Frequency [Hz]

2.2 Hysteresis width vs. Junction temperature





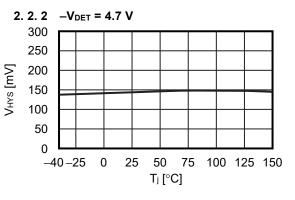
1k

Frequency [Hz]

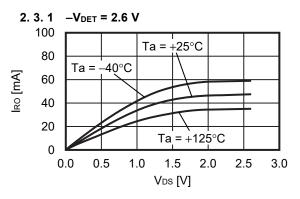
10k

100k

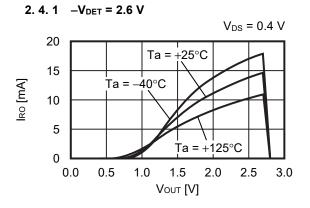
1M



2.3 Reset output current vs. VDs

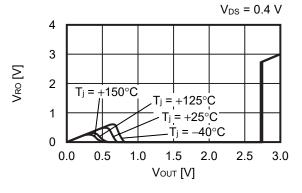


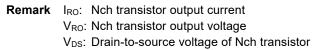
2.4 Reset output current vs. Output voltage

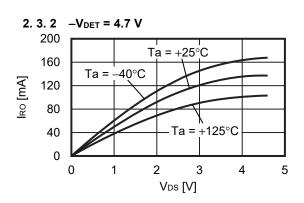


2.5 RO pin voltage vs. Output voltage

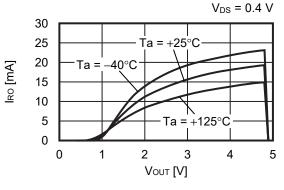
2.5.1 -V_{DET} = 2.6 V

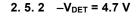


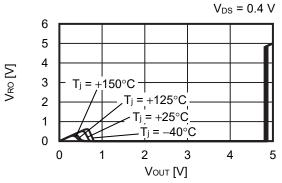




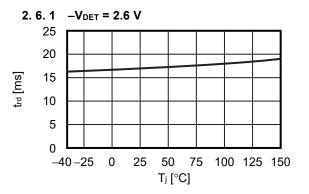


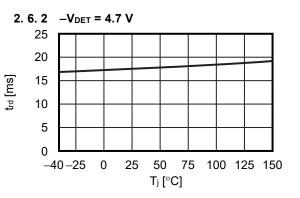




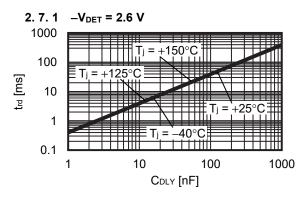


2. 6 Release delay time vs. Junction temperature

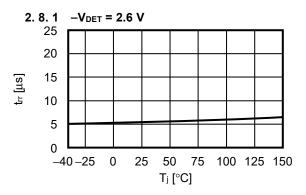


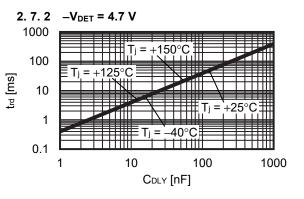


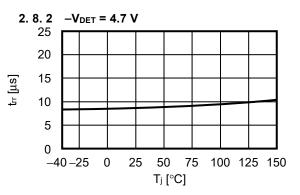
2.7 Release delay time vs. Release delay time adjustment capacitance

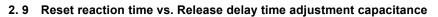


2.8 Reset reaction time vs. Junction temperature

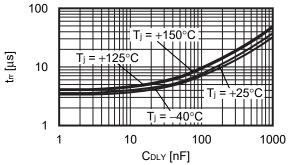


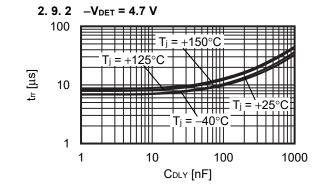




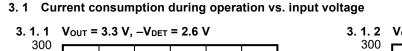


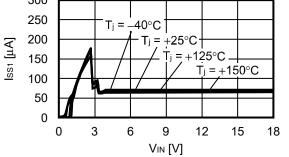
2.9.1 -VDET = 2.6 V

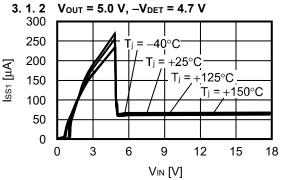




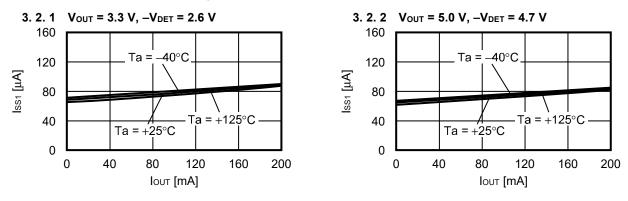
3. Overall



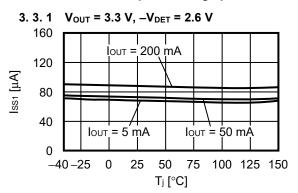


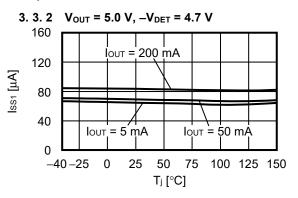


3. 2 Current consumption during operation vs. Output current



3.3 Current consumption during operation vs. Junction temperature





Reference Data

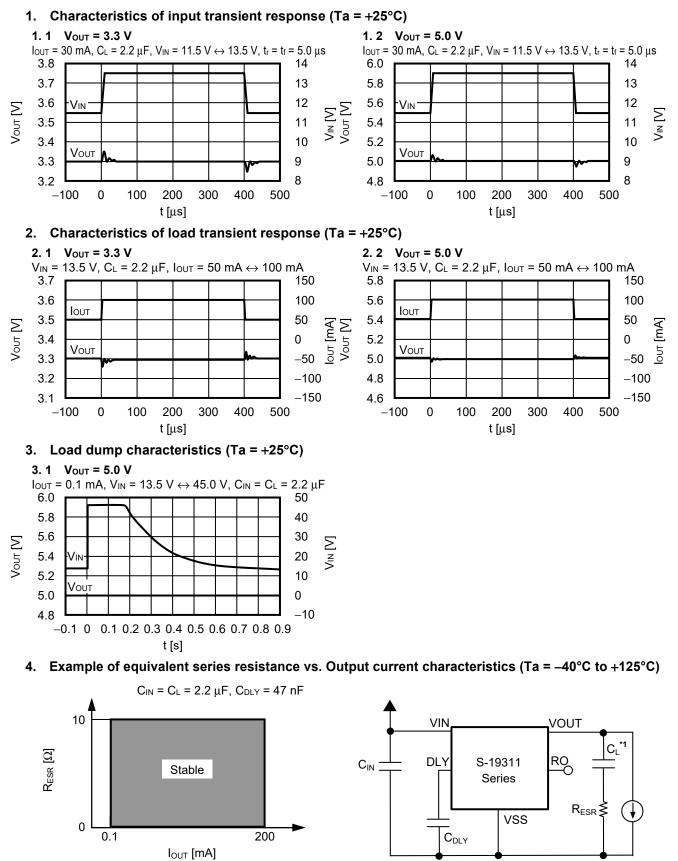


Figure 17

ABLIC Inc.

*1.

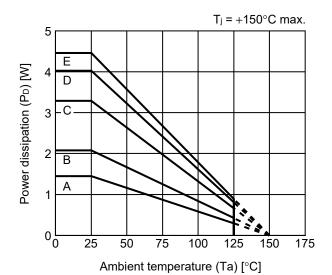
C_L: Murata Manufacturing Co., Ltd. GCM31CR71H225K (2.2 μF)

Figure 18

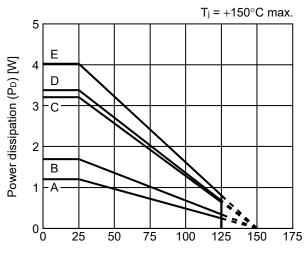
Power Dissipation

TO-252-5S(A)

HSOP-8A



Board	Power Dissipation (P _D)
А	1.45 W
В	2.08 W
С	3.29 W
D	4.03 W
E	4.46 W



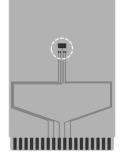
Ambient temperature (Ta) [°C]

Board	Power Dissipation (P _D)
А	1.20 W
В	1.69 W
С	3.21 W
D	3.38 W
E	4.03 W

TO-252-5S Test Board

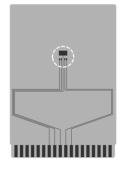
(1) Board A

🔵 IC Mount Area



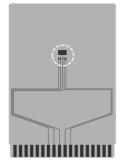
Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		2
	1	Land pattern and wiring for testing: t0.070
Copper foil layer [mm]	2	-
	3	-
	4	74.2 x 74.2 x t0.070
Thermal via		-

(2) Board B



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
	1	Land pattern and wiring for testing: t0.070
Copper foil layer [mm]	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		-

(3) Board C



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
	1	Land pattern and wiring for testing: t0.070
Copper foil layer [mm]	2	74.2 x 74.2 x t0.035
Copper foir layer [min]	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		Number: 4 Diameter: 0.3 mm



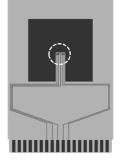
No. TO252-5S-A-Board-SD-1.0

TO-252-5S Test Board

(4) Board D

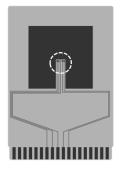
) IC Mount Area

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Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
	1	Pattern for heat radiation: 2000mm ² t0.070
Copper foil layer [mm]	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		-

(5) Board E



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
	1	Pattern for heat radiation: 2000mm ² t0.070
Copper foil layer [mm]	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		Number: 4 Diameter: 0.3 mm



No. TO252-5S-A-Board-SD-1.0

HSOP-8A Test Board

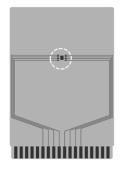
(1) Board A

🔵 IC Mount Area



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		2
	1	Land pattern and wiring for testing: t0.070
Copper foil layer [mm]	2	-
	3	-
	4	74.2 x 74.2 x t0.070
Thermal via		-

(2) Board B



Item		Specification	
Size [mm]		114.3 x 76.2 x t1.6	
Material		FR-4	
Number of copper foil layer		4	
Copper foil layer [mm]	1	Land pattern and wiring for testing: t0.070	
	2	74.2 x 74.2 x t0.035	
	3	74.2 x 74.2 x t0.035	
	4	74.2 x 74.2 x t0.070	
Thermal via		-	

(3) Board C



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
Copper foil layer [mm]	1	Land pattern and wiring for testing: t0.070
	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		Number: 4 Diameter: 0.3 mm

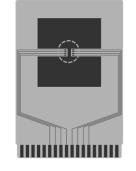


enlarged view

No. HSOP8A-A-Board-SD-1.0

HSOP-8A Test Board

(4) Board D



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
Copper foil layer [mm]	1	Pattern for heat radiation: 2000mm2 t0.070
	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		-

IC Mount Area

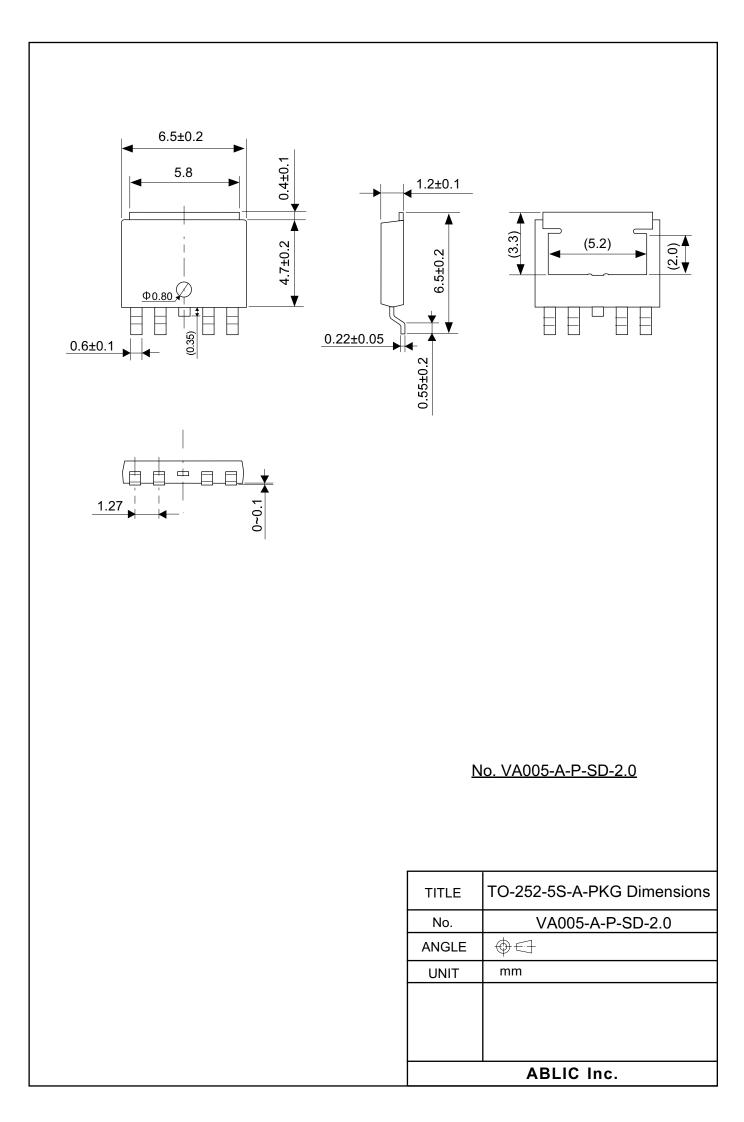
(5) Board E

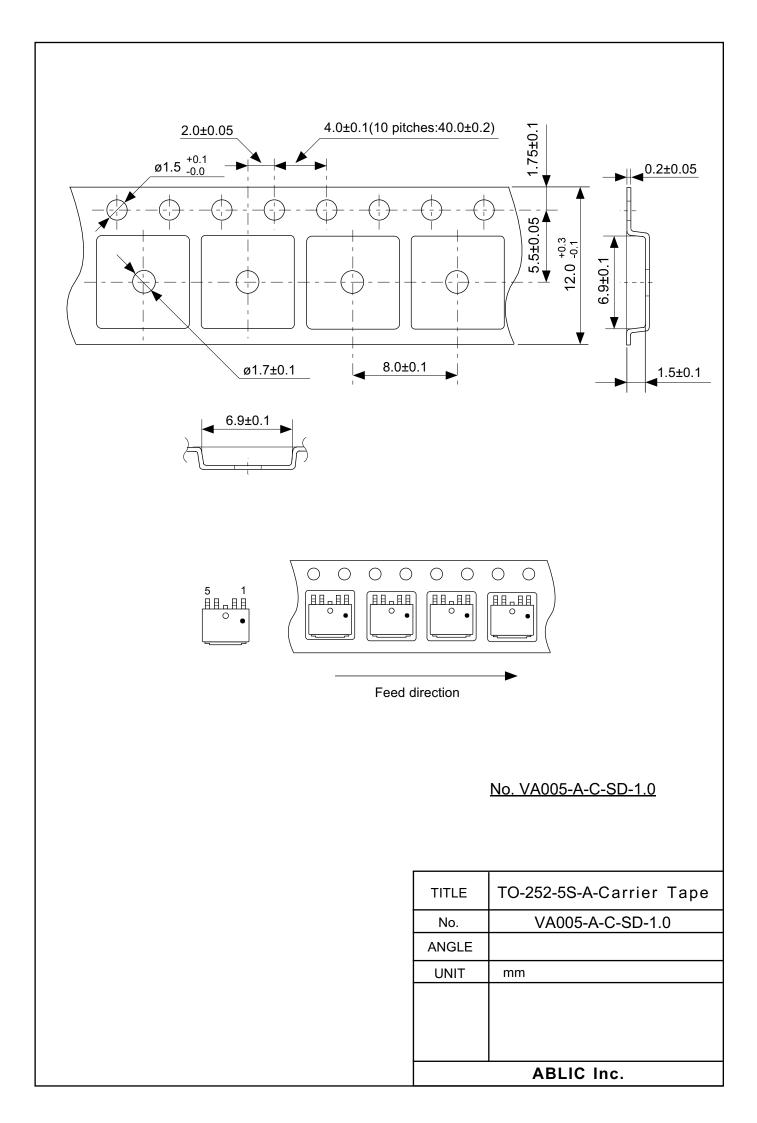
Item		Specification	
Size [mm]		114.3 x 76.2 x t1.6	
Material		FR-4	
Number of copper foil layer		4	
Copper foil layer [mm]	1	Pattern for heat radiation: 2000mm ² t0.070	
	2	74.2 x 74.2 x t0.035	
	3	74.2 x 74.2 x t0.035	
	4	74.2 x 74.2 x t0.070	
Thermal via		Number: 4 Diameter: 0.3 mm	

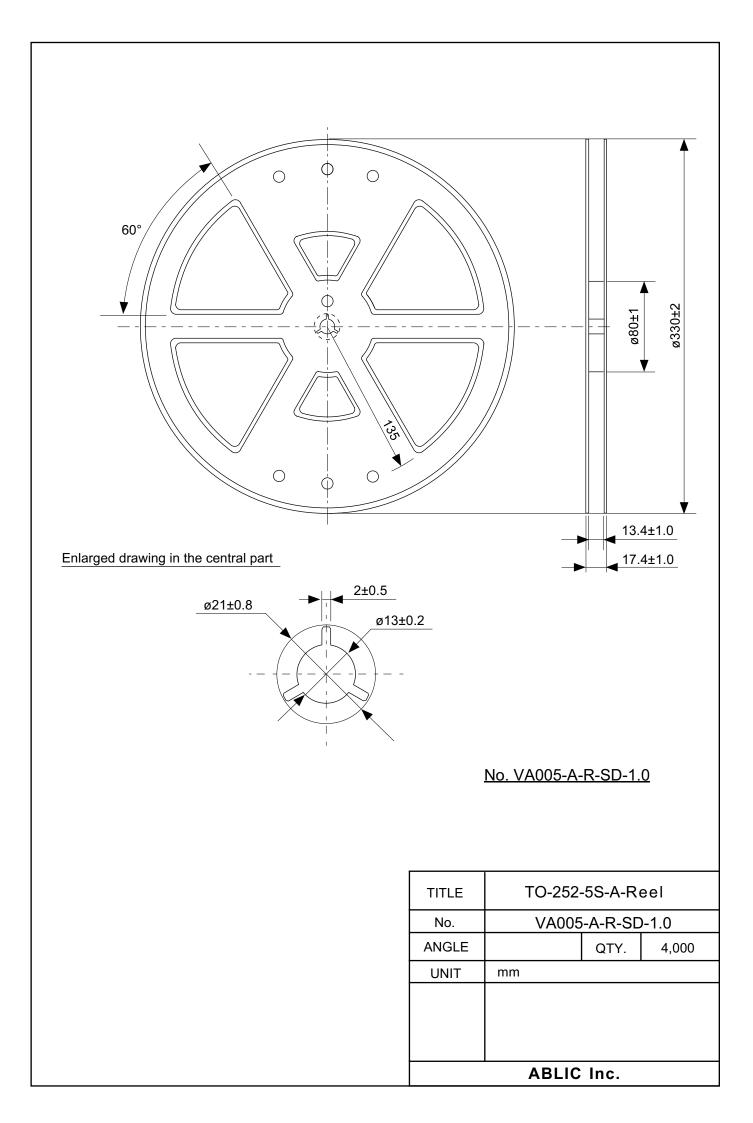
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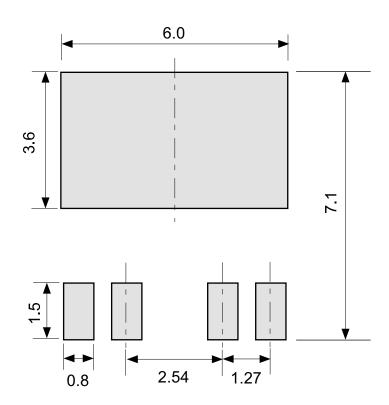
enlarged view

No. HSOP8A-A-Board-SD-1.0



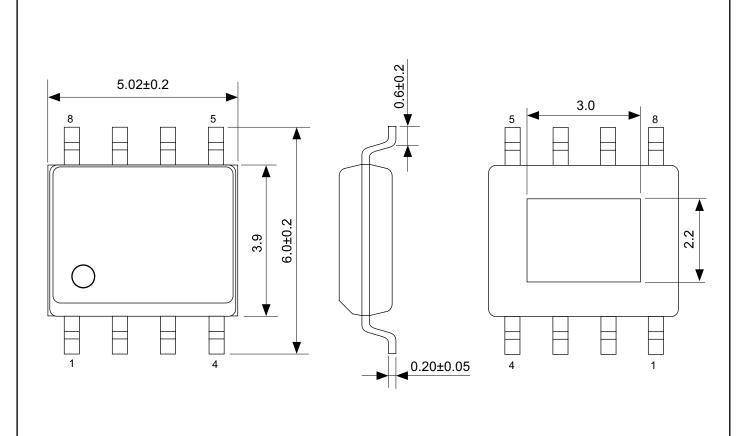


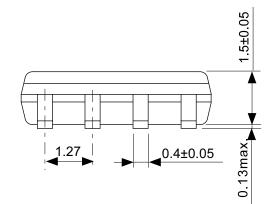




No. VA005-A-L-SD-1.0

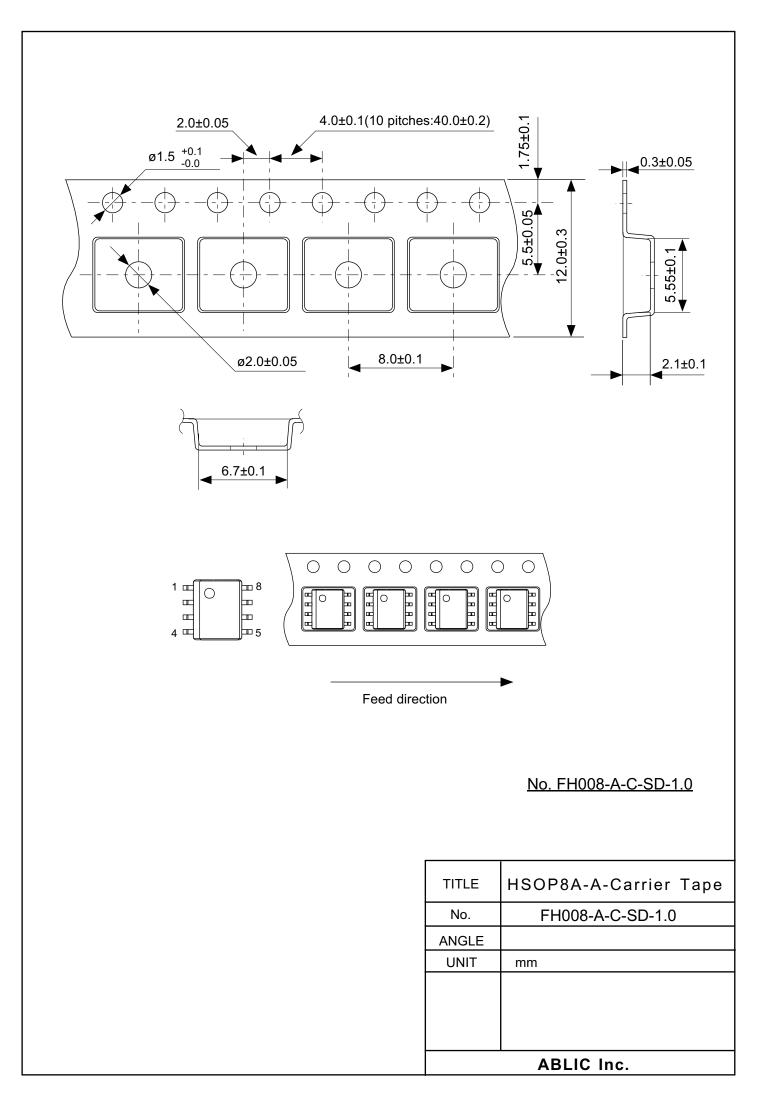
TITLE	TO-252-5S-A -Land Recommendation	
No.	VA005-A-L-SD-1.0	
ANGLE		
UNIT	mm	
ABLIC Inc.		

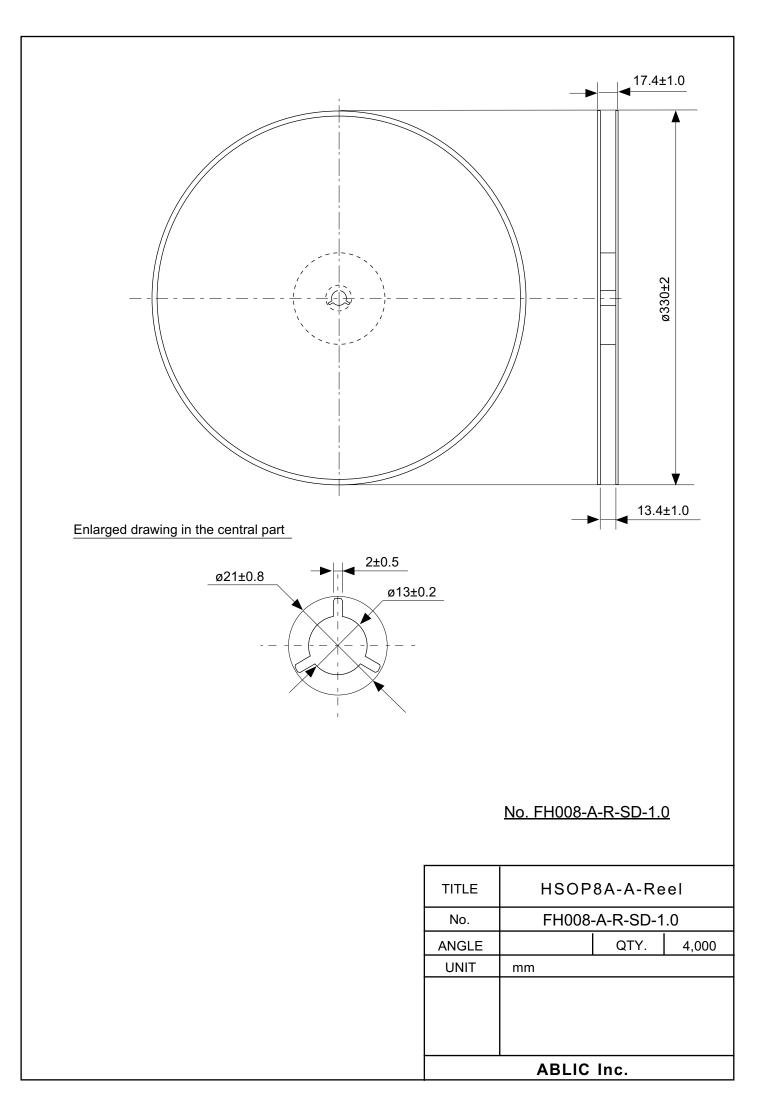




No. FH008-A-P-SD-2.0

TITLE	HSOP8A-A-PKG Dimensions	
No.	FH008-A-P-SD-2.0	
ANGLE	\oplus	
UNIT	mm	
ABLIC Inc.		





0.76 1.5 2.4 4<u>.</u>0 7.0 3.2 ¥_ 1.5 V V I I 1.27 1.27 1.27 4

No. FH008-A-L-SD-1.0

TITLE	HSOP8A-A -Land Recommendation	
No.	FH008-A-L-SD-1.0	
ANGLE		
UNIT	mm	
ABLIC Inc.		

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2.4-2019.07